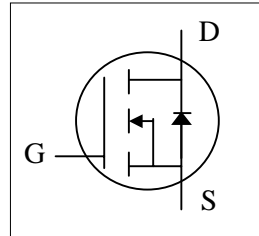




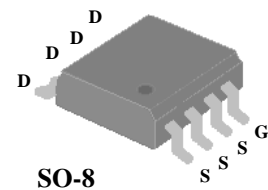
- ▼ **Low On-Resistance**
- ▼ **Simple Drive Requirement**
- ▼ **Fast Switching Characteristic**



BV_{DSS}	30V
$R_{DS(ON)}$	11mΩ
I_D	12A

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, ultra low on-resistance and cost-effectiveness.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	+20	V
$I_D@T_A=25^\circ C$	Continuous Drain Current ³	12	A
$I_D@T_A=70^\circ C$	Continuous Drain Current ³	9.8	A
I_{DM}	Pulsed Drain Current ¹	60	A
$P_D@T_A=25^\circ C$	Total Power Dissipation	2.5	W
	Linear Derating Factor	0.02	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-a	Maximum Thermal Resistance, Junction-ambient ³	50	°C/W



AP6680AGM

Electrical Characteristics @ $T_j=25^{\circ}\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
$\Delta BV_{DSS}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_D=1\text{mA}$	-	0.02	-	$\text{V}/^{\circ}\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	$V_{GS}=10V, I_D=12A$	-	-	11	$\text{m}\Omega$
		$V_{GS}=4.5V, I_D=8A$	-	-	16.5	$\text{m}\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.8	-	2.5	V
g_{fs}	Forward Transconductance	$V_{DS}=10V, I_D=12A$	-	12	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=30V, V_{GS}=0V$	-	-	1	μA
	Drain-Source Leakage Current ($T_j=70^{\circ}\text{C}$)	$V_{DS}=24V, V_{GS}=0V$	-	-	25	μA
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 20V$	-	-	± 100	nA
Q_g	Total Gate Charge ²	$I_D=12A$	-	17	27	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=25V$	-	2.7	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=4.5V$	-	9.9	-	nC
$t_{d(on)}$	Turn-on Delay Time ²	$V_{DS}=15V$	-	9	-	ns
t_r	Rise Time	$I_D=1A$	-	6	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=3.3\Omega, V_{GS}=10V$	-	29	-	ns
t_f	Fall Time	$R_D=15\Omega$	-	8	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	1000	1600	pF
C_{oss}	Output Capacitance	$V_{DS}=25V$	-	220	-	pF
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	175	-	pF
R_g	Gate Resistance	$f=1.0\text{MHz}$	-	1	1.5	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_S=2.1A, V_{GS}=0V$	-	-	1.2	V
t_{rr}	Reverse Recovery Time ²	$I_S=12A, V_{GS}=0V,$	-	26	-	ns
Q_{rr}	Reverse Recovery Charge	$di/dt=100A/\mu s$	-	20	-	nC

Notes:

1. Pulse width limited by Max. junction temperature.
2. Pulse test
3. Surface mounted on 1 in² copper pad of FR4 board, $t \leq 10\text{sec}$; $125^{\circ}\text{C}/W$ when mounted on Min. copper pad.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

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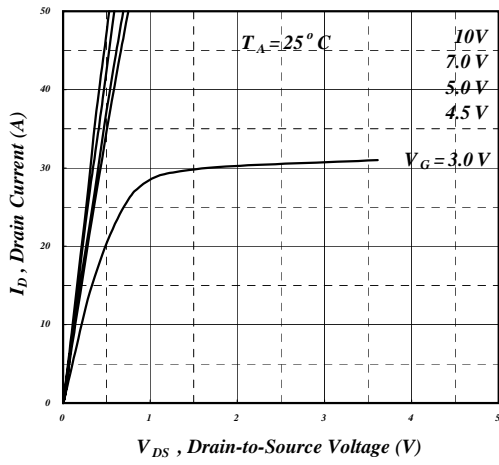


Fig 1. Typical Output Characteristics

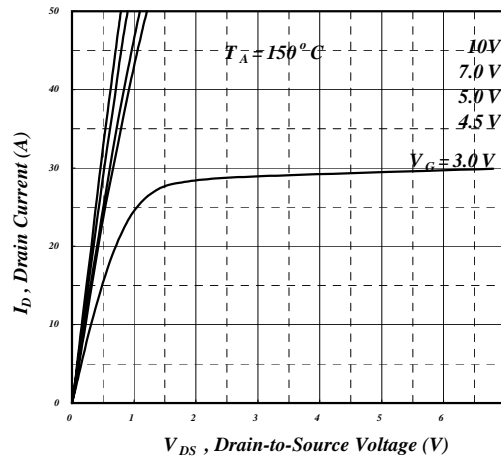


Fig 2. Typical Output Characteristics

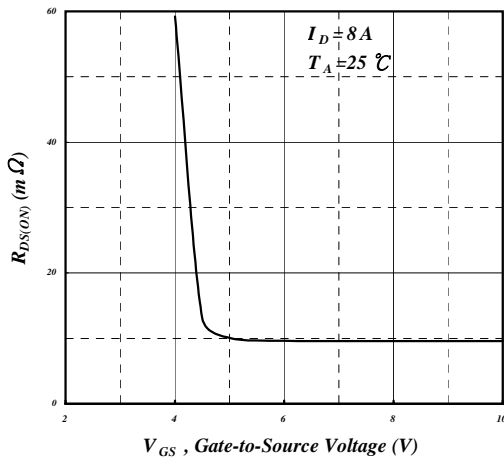


Fig 3. On-Resistance v.s. Gate Voltage

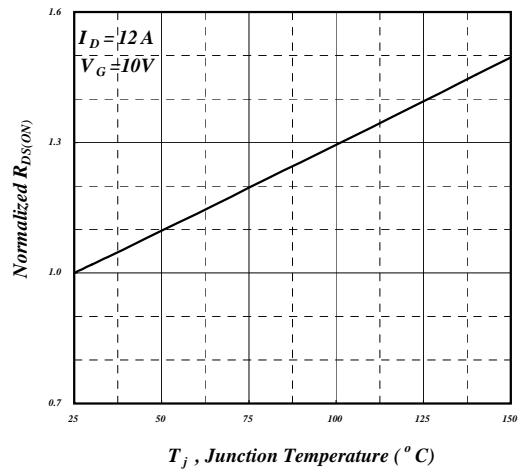


Fig 4. Normalized On-Resistance v.s. Junction Temperature

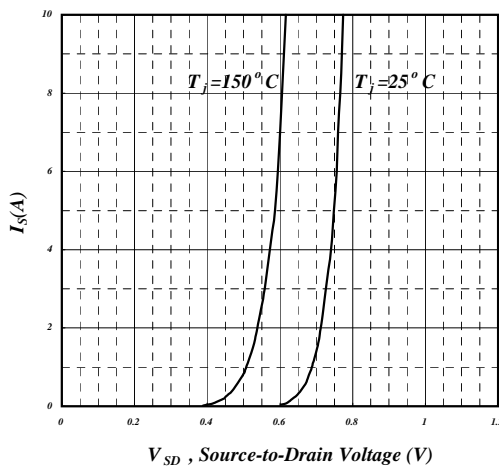


Fig 5. Forward Characteristic of Reverse Diode

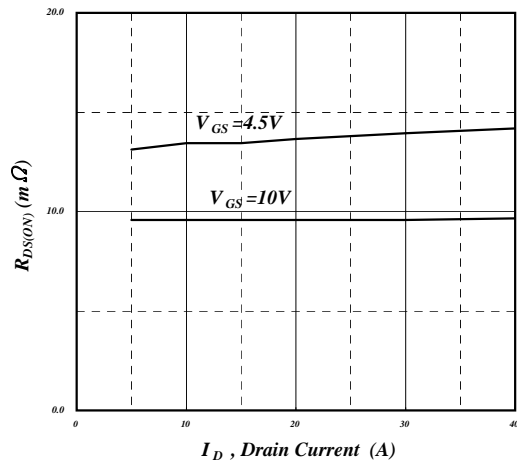


Fig 6. On-Resistance vs. Drain Current

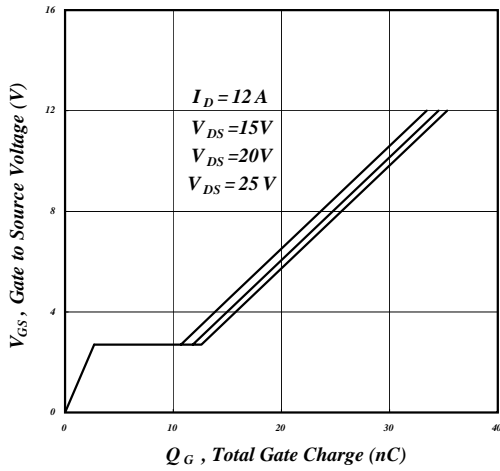


Fig 7. Gate Charge Characteristics

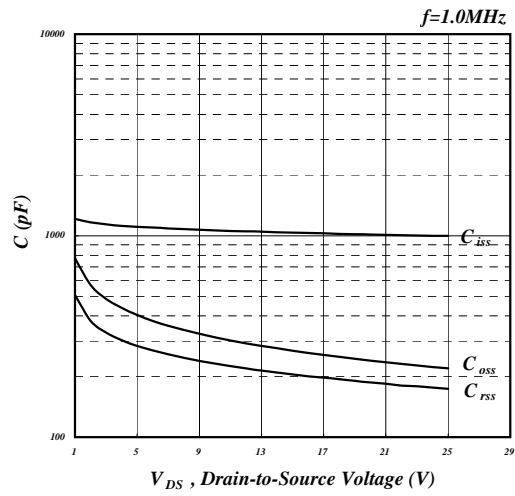


Fig 8. Typical Capacitance Characteristics

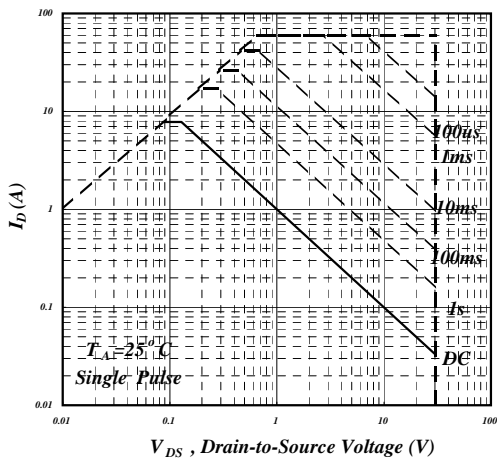


Fig 9. Maximum Safe Operating Area

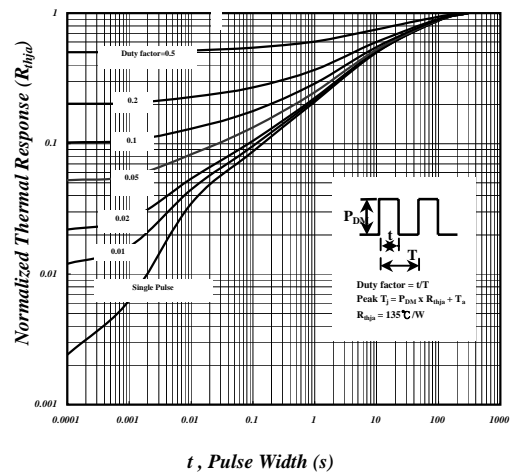


Fig 10. Effective Transient Thermal Impedance

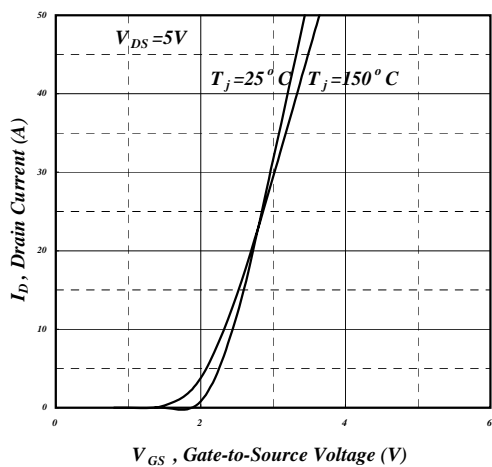


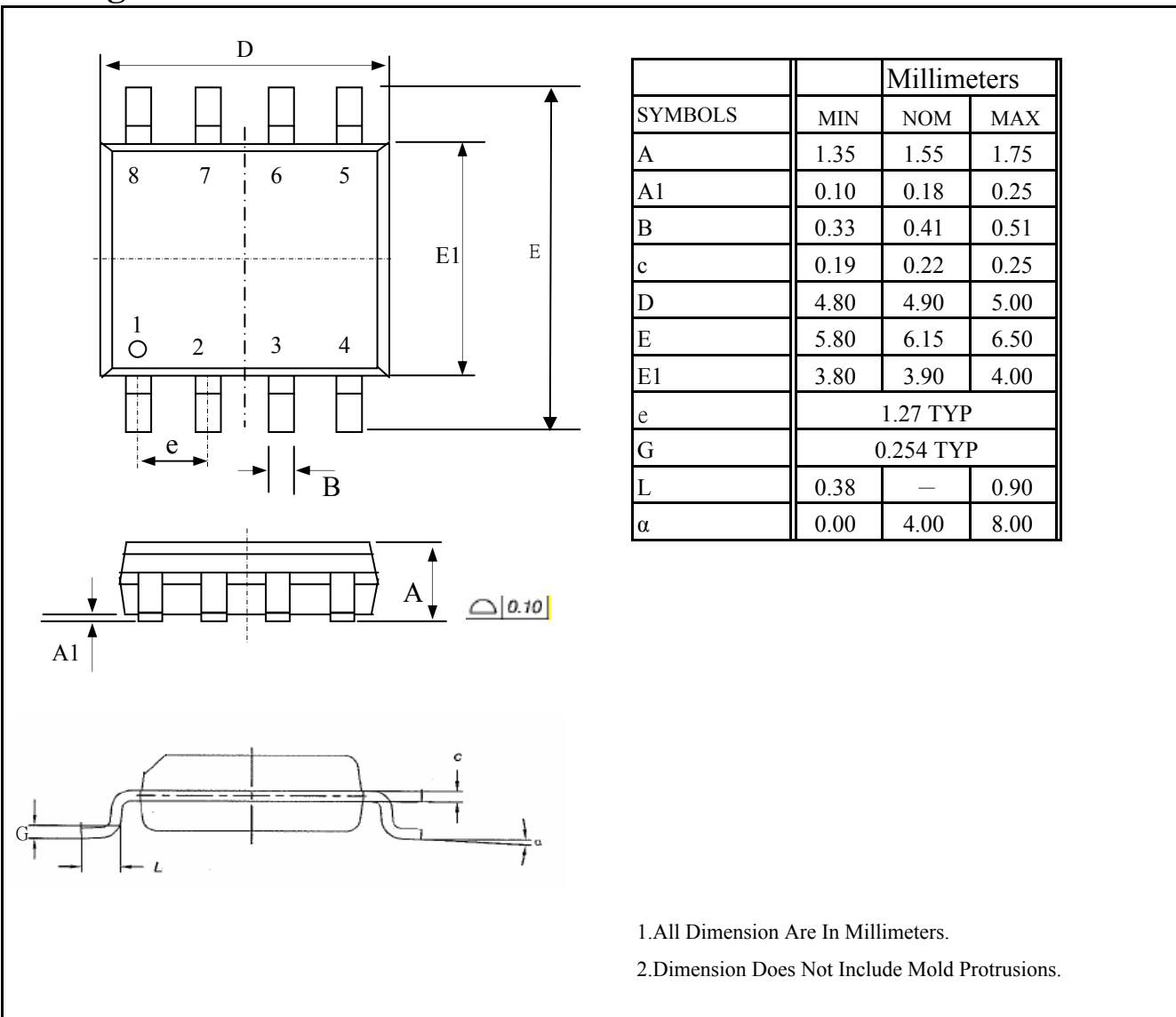
Fig 11. Transfer Characteristics



Fig 12. Gate Charge Waveform



Package Outline : SO-8



Part Marking Information & Packing : SO-8

